

September 2015

FDS89161LZ

Dual N-Channel Shielded Gate PowerTrench[®] MOSFET 100 V, 2.7 A, 105 m Ω

Features

- Shielded Gate MOSFET Technology
- Max $r_{DS(on)}$ = 105 m Ω at V_{GS} = 10 V, I_D = 2.7 A
- Max $r_{DS(on)}$ = 160 m Ω at V_{GS} = 4.5 V, I_D = 2.1 A
- High performance trench technology for extremely low r_{DS(on)}
- High power and current handling capability in a widely used surface mount package
- CDM ESD protection level > 2KV typical (Note 4)
- 100% UIL Tested
- RoHS Compliant



General Description

This N-Channel logic Level MOSFETs are produced using Fairchild Semiconductor's advanced PowerTrench[®] process that incorporates Shielded Gate technology. This process has been optimized for the on-state resisitance and yet maintain superior switching performance. G-S zener has been added to enhance ESD voltage level.

G2

3 S2

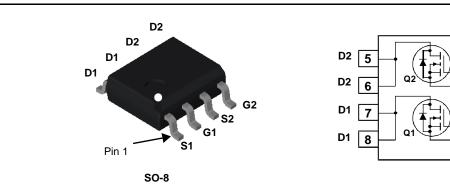
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2 G1

1 S1

Application

■ DC-DC conversion



MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			100	V	
V _{GS}	Gate to Source Voltage			±20	V	
1	Drain Current -Continuous			2.7	•	
D	-Pulsed			15	— A	
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	13	mJ	
P _D	Power Dissipation	T _C = 25 °C		31	w	
	Power Dissipation	T _A = 25 °C	(Note1a)	1.6	vv	
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	

Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance, Junction to Case	(Note 1)	40	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient	(Note 1a)	78	C/VV

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDS89161LZ	FDS89161LZ	SO-8	13 "	12 mm	2500 units

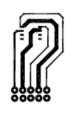
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units	
Off Chara	acteristics						
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	100			V	
ΔBV _{DSS} ΔT _J	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, referenced to 25 °C		68		mV/°C	
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 80 V, V _{GS} = 0 V			1	μA	
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±10	μA	
On Chara	icteristics					-	
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$	1	1.7	2.2	V	
$\Delta V_{GS(th)}$ ΔT_J	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, referenced to 25 °C		-6		mV/°C	
r _{DS(on)}	Static Drain to Source On Resistance	$V_{GS} = 10 \text{ V}, I_D = 2.7 \text{ A}$		81	105		
		V _{GS} = 4.5 V, I _D = 2.1 A		110	160	mΩ	
		V_{GS} = 10 V, I_D = 2.7 A, T_J = 125 °C		140	182		
9fs	Forward Transconductance	$V_{DS} = 10 \text{ V}, \ \text{I}_{D} = 2.7 \text{ A}$		7.8		S	
	Characteristics			227	302	۶Ę	
C _{iss}	Input Capacitance Output Capacitance	$V_{DS} = 50 V, V_{GS} = 0 V,$		44	58	pF pF	
C _{oss} C _{rss}	Reverse Transfer Capacitance	f = 1MHz		3	4	pF	
R _a	Gate Resistance			0.9		Ω	
9	g Characteristics						
	Turn-On Delay Time			3.8	10	ns	
t _{d(on)} t _r	Rise Time	V _{DD} = 50 V, I _D = 2.7 A,		1.2	10	ns	
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		9.5	17	ns	
t _f	Fall Time			1.6	10	ns	
	Total Gate Charge	V _{GS} = 0 V to 10 V		3.8	5.3	nC	
$Q_{q(TOT)}$	Total Gate Charge	$V_{GS} = 0 \text{ V to 5 V} \text{ V}_{DD} = 50 \text{ V},$		2.1	2.9	nC	
Q _{gs}	Gate to Source Charge	I _D = 2.7 A		0.7		nC	
Q _{gd}	Gate to Drain "Miller" Charge			0.7		nC	
Drain-Sou	urce Diode Characteristics						
V _{SD}		$V_{GS} = 0 V, I_{S} = 2.7 A$ (Note 2)		0.8	1.3		
	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 2 A$ (Note 2)		0.8	1.2	V	
t _{rr}	Reverse Recovery Time			31	56	ns	
Q _{rr}	Reverse Recovery Charge	– I _F = 2.7 A, di/dt = 100 A/μs		20	36	nC	

NOTES:

1. R_{0,JA} is determined with the device mounted on a 1in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{0,JC} is guaranteed by design while R_{0CA} is determined by the user's board design.

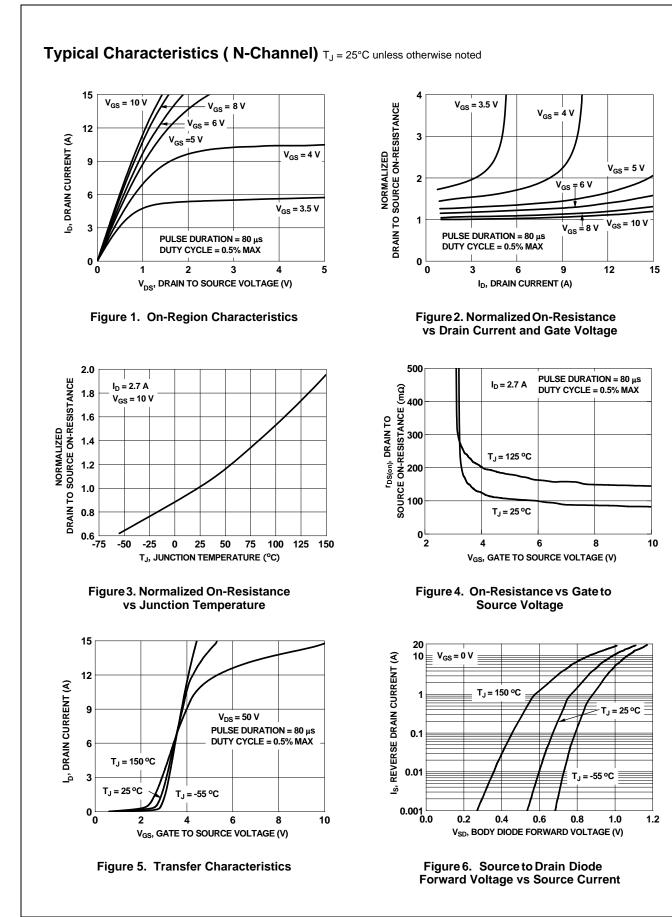






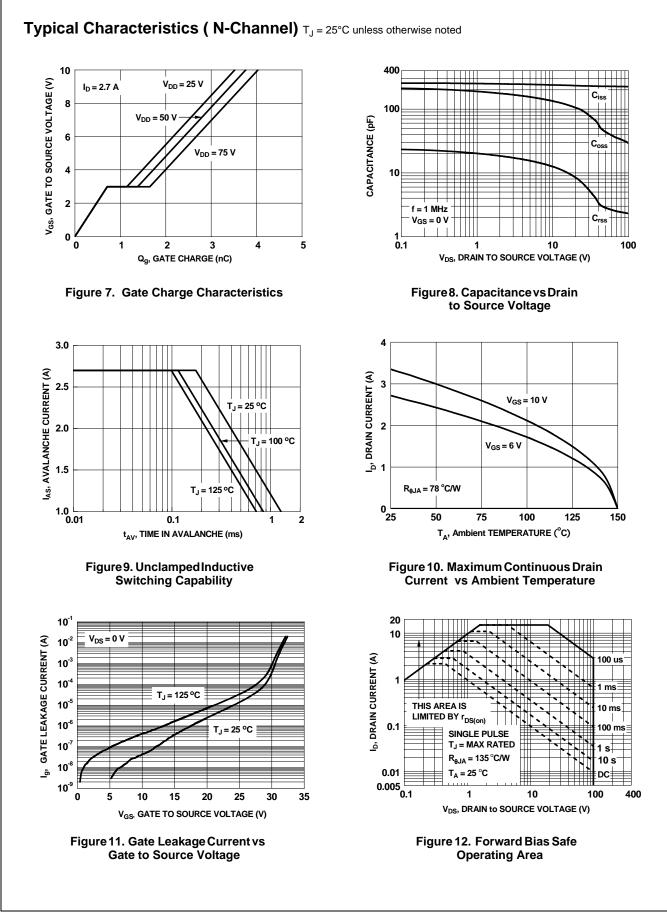
b) 135°C/W when mounted on a minimun pad

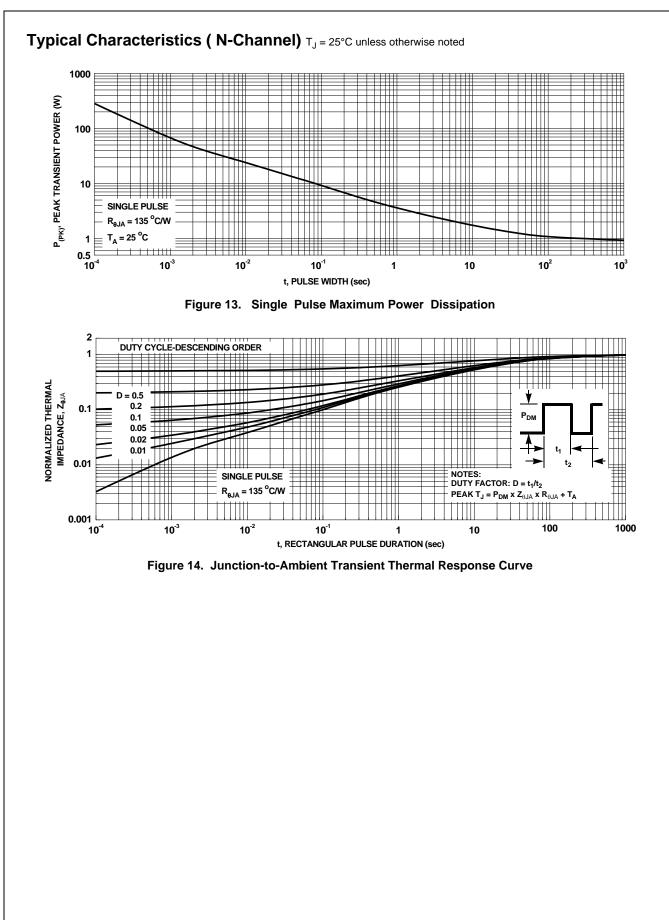
Pulse Test: Pulse Width < 300μs, Duty cycle < 2.0%.
 Starting TJ = 25 °C, L = 0.3 mH, IAS =25 A, VDD = 27 V, VGS = 10V.
 The diode connected between gate and source serves only as protection against ESD. No gate overvoltage rating is implied.



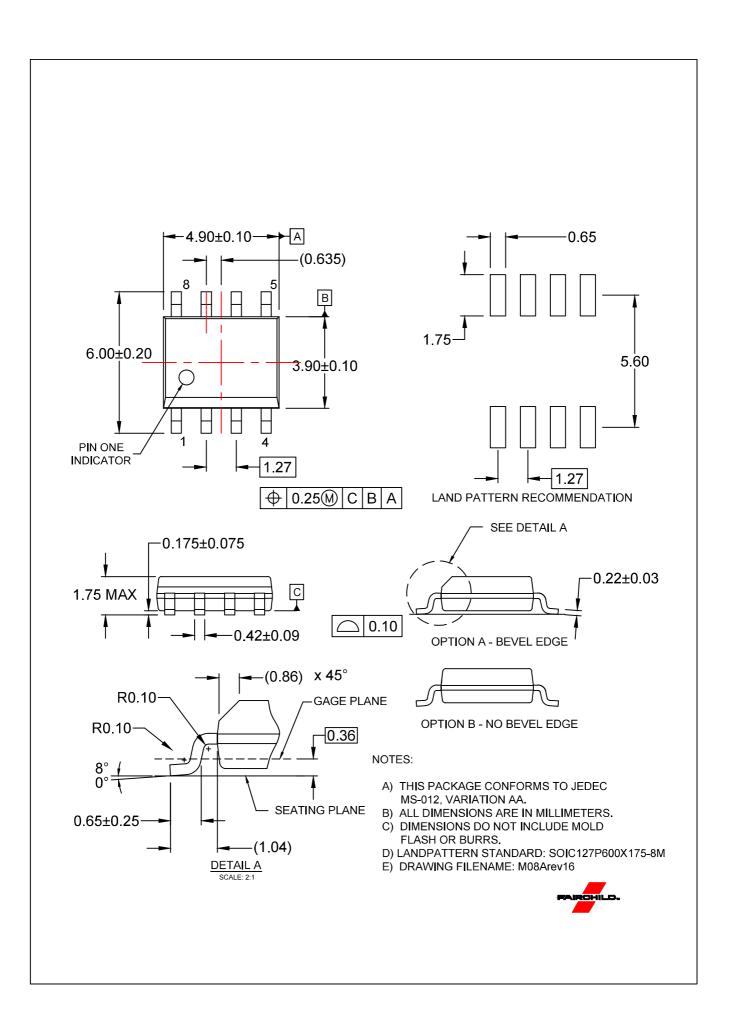
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5





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